

# LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263C – AUGUST 1999 – REVISED MARCH 2000

- **2.7-V and 5-V Performance**
- **No Crossover Distortion**
- **Low Supply Current:**  
 LMV321 . . . 130  $\mu$ A Typ  
 LMV358 . . . 210  $\mu$ A Typ  
 LMV324 . . . 410  $\mu$ A Typ
- **Rail-to-Rail Output Swing**
- **Package Options Include Plastic Small-Outline (D), Small-Outline Transistor (SOT-23 DBV, SC-70 DCK), and Thin Shrink Small-Outline (PW) Packages**

## description

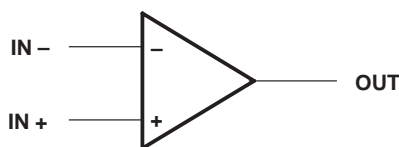
The LMV324 and LMV358 are low-voltage (2.7 V to 5.5 V) versions of the dual and quad operational amplifiers, LM324 and LM358, that operate from 5 V to 30 V. The LMV321 is the single-amplifier version.

The LMV321, LMV324, and LMV358 are the most cost-effective solutions for applications where low-voltage operation, space saving, and low price are needed. They offer specifications that meet or exceed those of the familiar LM358 and LM324 devices. These devices have rail-to-rail output-swing capability, and the input common-mode voltage range includes ground. They all exhibit excellent speed-to-power ratios, achieving 1MHz of bandwidth at 1-V/ $\mu$ s slew rate with low supply current.

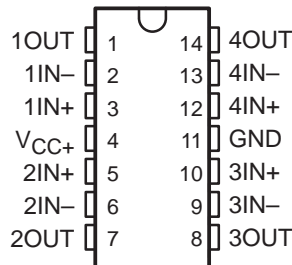
The LMV321 is available in the ultra-small DCK package, which is approximately one-half the size of the DBV package. This package saves space on printed circuit boards and enables the design of small portable electronic devices. It also allows the designer to place the device closer to the signal source to reduce noise pickup and increase signal integrity.

The LMV321I, LMV324I, and LMV358I devices are characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

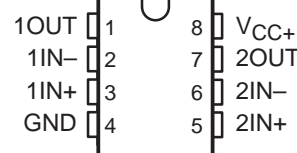
## symbol (each amplifier)



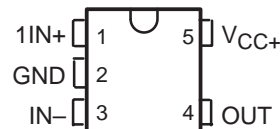
LMV324 . . . D OR PW PACKAGE  
(TOP VIEW)



LMV358 . . . D OR PW PACKAGE  
(TOP VIEW)



LMV321 . . . DBV OR DCK PACKAGE  
(TOP VIEW)



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## AVAILABLE OPTIONS

T <sub>A</sub>	PACKAGE TYPE	PACKAGED DEVICES		
		SINGLE	DUAL	QUADRUPLE
-40°C to 85°C	5-pin SOT	LMV321DCKR LMV321IDBVR	— —	— —
	8-pin SOIC 8-pin TSSOP	— —	LMV358ID LMV358IPWR	— —
	14-pin SOIC 14-pin TSSOP	— —	—	LMV324ID LMV324IPWR

The D package is available taped and reeled. Add the suffix R to the device type (e.g., LMV324DR). The DCK, DBV, and PW packages are only available left-end taped and reeled.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)	5.5 V
Differential input voltage, V <sub>ID</sub> (see Note 2)	±5.5 V
Input voltage, V <sub>I</sub> (either input)	0 to 5.5 V
Duration of output short circuit (one amplifier) to ground at (or below) T <sub>A</sub> = 25°C, V <sub>CC</sub> ≤ 5.5 V (see Note 3)	Unlimited
Operating virtual junction temperature	150°C
Package thermal impedance, θ <sub>JA</sub> (see Notes 4 and 5):	
D (8-pin) package	197°C/W
D (14-pin) package	127°C/W
DBV package	347°C/W
DCK package	389°C/W
PW (8-pin) package	243°C/W
PW (14-pin) package	170°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds:	
D or PW package	260°C
DBV or DCK package	TBD
Storage temperature range, T <sub>stg</sub>	-65 to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
- All voltage values (except differential voltages and V<sub>CC</sub> specified for the measurement of I<sub>OS</sub>) are with respect to the network GND.
  - Differential voltages are at IN+ with respect to IN-.
  - Short circuits from outputs to V<sub>CC</sub> can cause excessive heating and eventual destruction.
  - Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> - T<sub>A</sub>)/θ<sub>JA</sub>. Selecting the maximum of 150°C can impact reliability.
  - The package thermal impedance is calculated in accordance with JESD 51.

## recommended operating conditions

	MIN	MAX	UNIT
V <sub>CC</sub> Supply voltage (single-supply operation)	2.7	5.5	V
T <sub>A</sub> Operating free-air temperature	-40	85	°C



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**electrical characteristics at  $T_A = 25^\circ\text{C}$  and  $V_{CC+} = 2.7\text{ V}$  (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{IO}$	Input offset voltage			1.7	7	mV
$\alpha_{V_{IO}}$	Average temperature coefficient of input offset voltage			5		$\mu\text{V}/^\circ\text{C}$
$I_{IB}$	Input bias current			11	250	nA
$I_{IO}$	Input offset current			5	50	nA
CMRR	Common-mode rejection ratio	$V_{CM} = 0$ to 1.7 V	50	63		dB
$k_{SVR}$	Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V}$ to 5 V, $V_O = 1\text{ V}$	50	60		dB
$V_{ICR}$	Common-mode input voltage range	CMRR $\geq 50$ dB	0 to 1.7	-0.2 to 1.9		V
Output swing	$R_L = 10\text{ k}\Omega$ to 1.35 V	High level	$V_{CC}-100$	$V_{CC}-10$		mV
		Low level		60	180	
$I_{CC}$	Supply current	LMV321I		80	170	$\mu\text{A}$
		LMV358I (both amplifiers)		140	340	
		LMV324I (all four amplifiers)		260	680	
$B_1$	Unity-gain bandwidth	$C_L = 200\text{ pF}$		1		MHz
$\Phi_m$	Phase margin			60		deg
$G_m$	Gain margin			10		dB
$V_n$	Equivalent input noise voltage	$f = 1\text{ kHz}$		46		$\text{nV}/\sqrt{\text{Hz}}$
$I_n$	Equivalent input noise current	$f = 1\text{ kHz}$		0.17		$\text{pA}/\sqrt{\text{Hz}}$

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electrical characteristics at specified free-air temperature range,  $V_{CC+} = 5\text{ V}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	$T_A$	MIN	TYP	MAX	UNIT	
$V_{IO}$	Input offset voltage		25°C		1.7	7	mV	
			-40°C to 85°C			9		
$\alpha_{V_{IO}}$	Average temperature coefficient of input offset voltage		25°C		5		$\mu\text{V}/^\circ\text{C}$	
$I_{IB}$	Input bias current		25°C		15	250	nA	
			-40°C to 85°C			500		
$I_{IO}$	Input offset current		25°C		5	50	nA	
			-40°C to 85°C			150		
CMRR	Common-mode rejection ratio	$V_{CM} = 0$ to 4 V	25°C	50	65		dB	
$k_{SVR}$	Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V}$ to 5 V, $V_O = 1\text{ V}$ , $V_{CM} = 1\text{ V}$	25°C	50	60		dB	
$V_{ICR}$	Common-mode input voltage range	$CMRR \geq 50\text{ dB}$	25°C	0 to 4	-0.2 to 4.2		V	
Output swing		$R_L = 2\text{ k}\Omega$ to 2.5 V	High level	25°C	$V_{CC}-300$	$V_{CC}-40$	mV	
				-40°C to 85°C	$V_{CC}-400$			
			Low level	25°C		120		300
				-40°C to 85°C				400
		$R_L = 10\text{ k}\Omega$ to 2.5 V	High level	25°C	$V_{CC}-100$	$V_{CC}-10$		
				-40°C to 85°C	$V_{CC}-200$			
Low level	25°C		65	180				
	-40°C to 85°C			280				
$A_{VD}$	Large-signal differential voltage gain	$R_L = 2\text{ k}\Omega$	25°C	15	100	V/mV		
			-40°C to 85°C		10			
$I_{OS}$	Output short-circuit current	Sourcing, $V_O = 0\text{ V}$	25°C	5	60	mA		
		Sinking, $V_O = 5\text{ V}$		10	160			
$I_{CC}$	Supply current	LMV321I	25°C		130	250	$\mu\text{A}$	
			-40°C to 85°C			350		
		LMV358I (both amplifiers)	25°C		210	440		
			-40°C to 85°C			615		
		LMV324I (all four amplifiers)	25°C		410	830		
			-40°C to 85°C			1160		
$B_1$	Unity-gain bandwidth	$C_L = 200\text{ pF}$	25°C		1	MHz		
$\phi_m$	Phase margin		25°C		60	deg		
$G_m$	Gain margin		25°C		10	dB		
$V_n$	Equivalent input noise voltage	$f = 1\text{ kHz}$	25°C		39	$\text{nV}/\sqrt{\text{Hz}}$		
$I_n$	Equivalent input noise current	$f = 1\text{ kHz}$	25°C		0.21	$\text{pA}/\sqrt{\text{Hz}}$		
SR	Slew rate		25°C		1	$\text{V}/\mu\text{s}$		



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